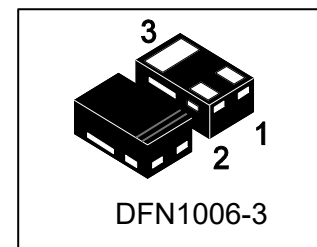
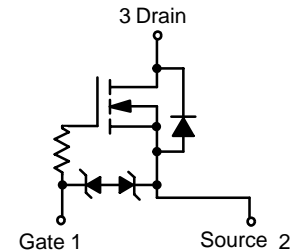


FEATURES

- Power MOSFET: 1.8-V Rated
- Gate-Source ESD Protected
- High-Side Switching
- Low On-Resistance: 0.4Ω
- Low Threshold: 0.8 V (typ)
- Fast Switching Speed: 10 ns
- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S- prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.



BENEFITS

- Ease in Driving Switches
- Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Battery Voltage Operation

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories.
- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
LM3043K	N5	10000/Tape&Reel

MAXIMUM RATINGS(Ta = 25 °C)

Parameter	Symbol	5 secs	Steady State	Unit
Drain-Source Voltage	VDS	20		V
Gate-Source Voltage	VGS	±8		V
Continuous Drain Current (TJ = 150°C) (Note 2)	ID	600	500	mA
		400	350	
Pulsed Drain Current(Note 1)	IDM	1000		
Continuous Source Current (diode conduction)(Note 2)	IS	275	250	
Maximum Power Dissipation(Note 2)	PD		250	mW
Thermal Resistance, Junction to Ambient	RθJA		500	°C/W
Operating Junction and Storage Temperature Range	TJ , Tstg	-55 ~+150		°C

1. Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board.

**ELECTRICAL CHARACTERISTICS (Ta= 25°C)**

Static

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Gate Threshold Voltage (VDS = VGS , ID = 250μA)	VGS(th)	0.35	-	1.0	V
Gate-Body Leakage (VDS = 0 V, VGS = ±4.5 V)	IGSS	-	±0.5	±1	μA
Zero Gate Voltage Drain Current (VDS = 20 V, VGS = 0 V) (VDS = 20 V, VGS = 0 V, TJ = 85°C)	IDSS	-	0.3	100	nA
		-	-	5	μA
On-State Drain Current(Note 1) (VDS = 5 V, VGS = 4.5 V)	ID(on)	700	-	-	mA
Drain-Source On-State Resistance(Note 1) (VGS = 4.5 V, ID = 500 mA) (VGS = 2.5 V, ID = 500 mA) (VGS = 1.8 V, ID = 350 mA)	RDS(on)		0.25 0.3 0.5	0.4 0.5 0.7	Ω
Forward Transconductance(Note 1) (VDS = 10 V, ID = 400 mA)	gfs		1		S
Diode Forward Voltage(Note 1) (IS = 150 mA, VGS = 0 V)	VSD		0.8	1.2	V

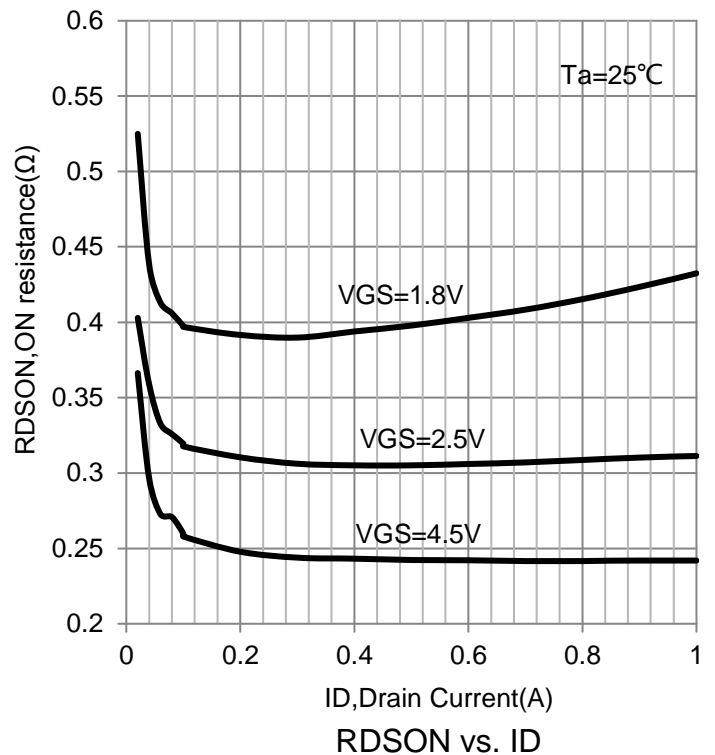
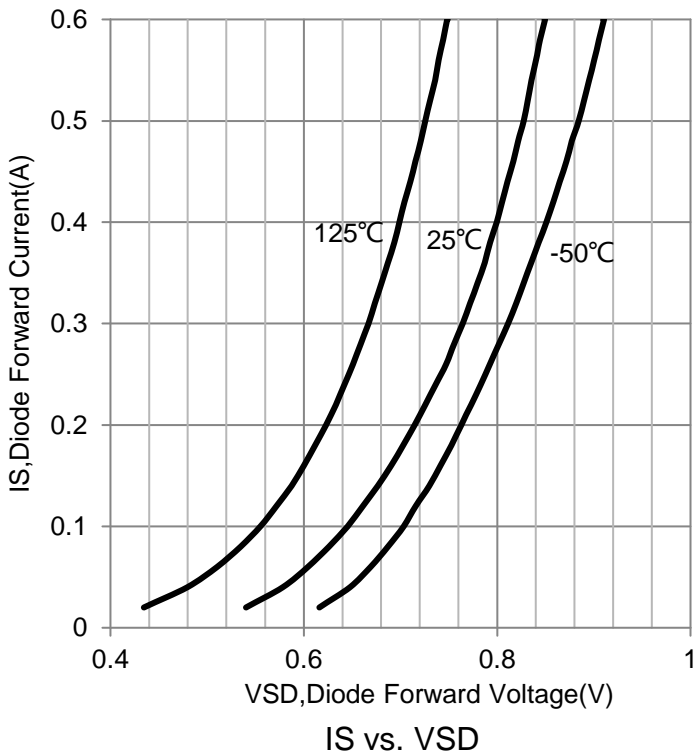
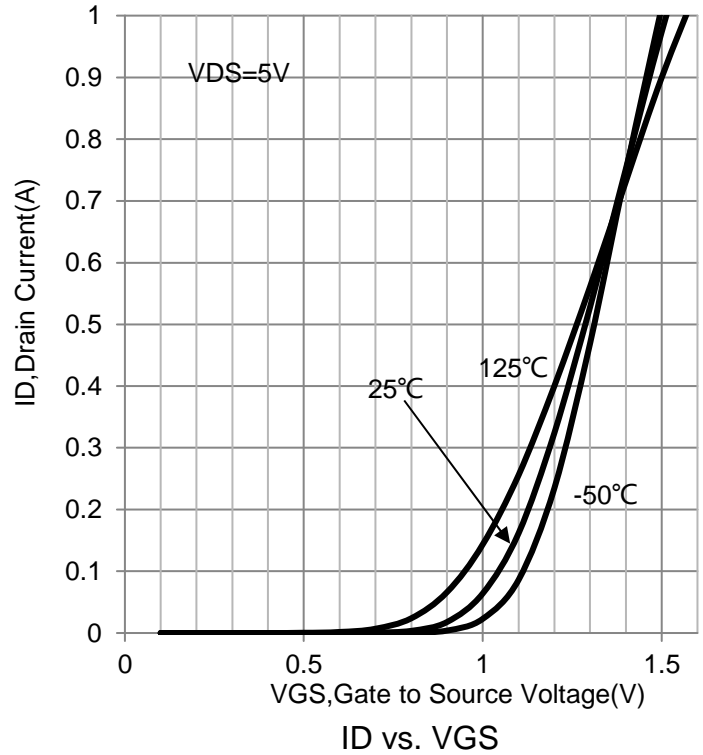
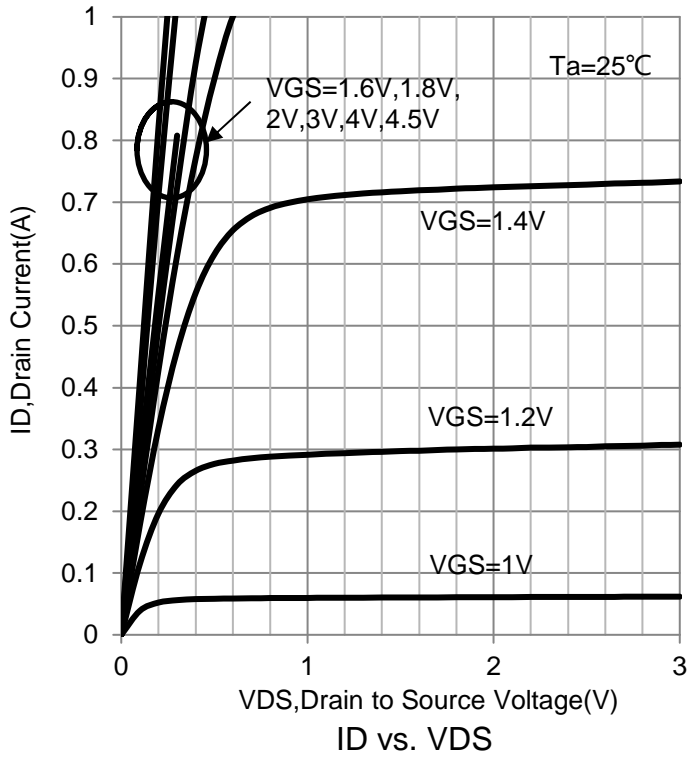
Dynamic(Note 2)

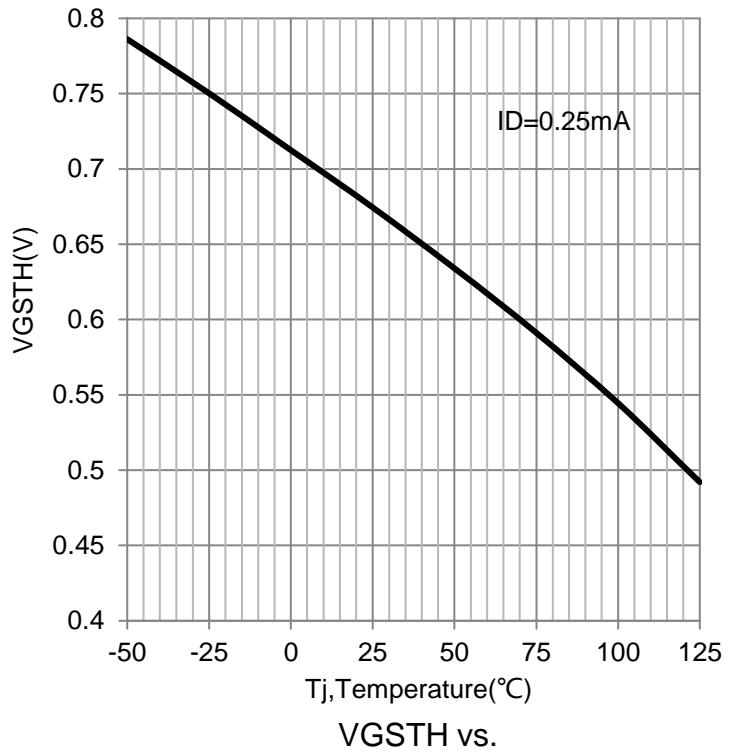
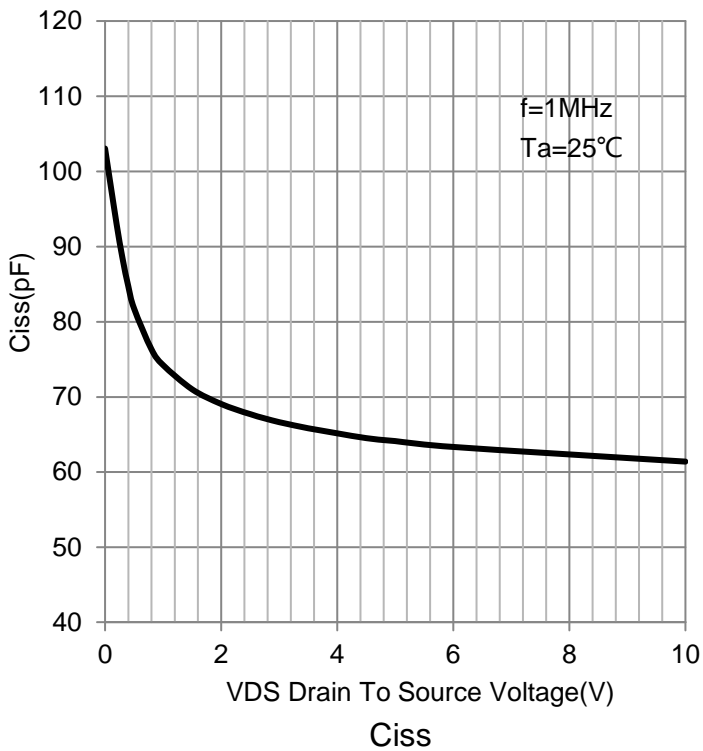
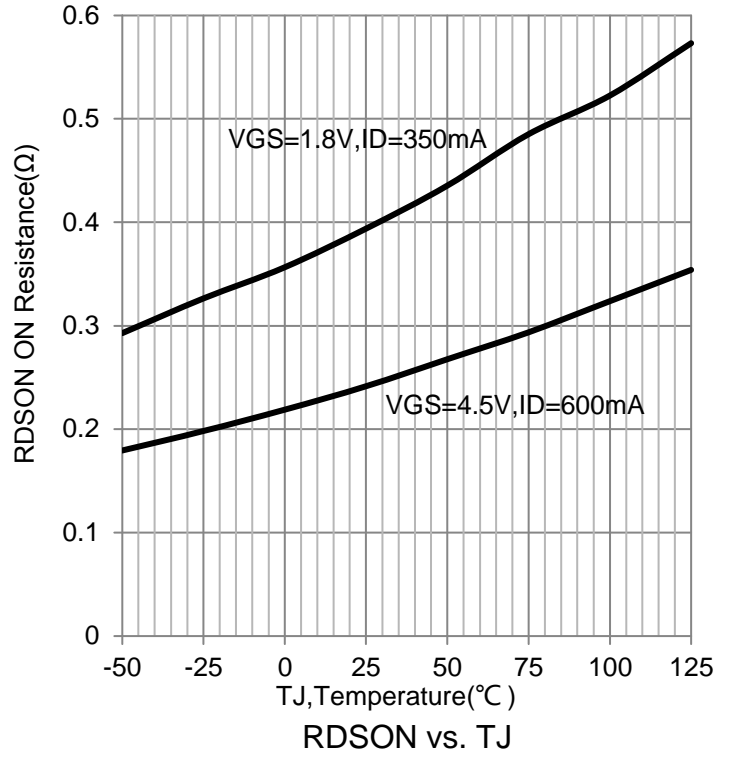
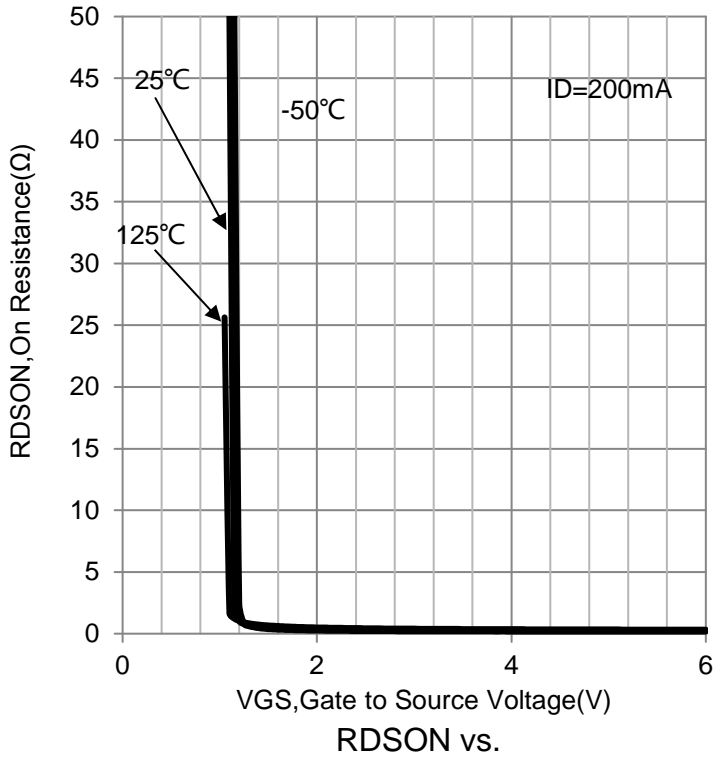
Total Gate Charge	(VDS = 10 V, VGS = 4.5 V, ID = 250 mA)	Qg	750		pC
Gate-Source Charge		Qgs	75		
Gate-Drain Charge		Qgd	225		
Turn-On Delay Time	(VDD = 10 V, RL = 47Ω, ID=200 mA, VGEN = 4.5 V, RG = 10Ω)	td(on)	5		ns
Rise Time		tr	5		
Turn-Off Delay Time		td(off)	25		
Fall Time		tf	11		

3. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.

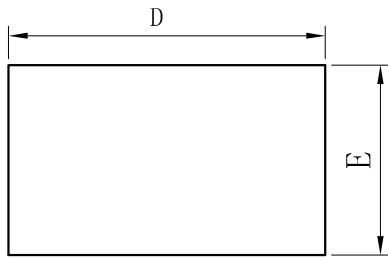
4. Guaranteed by design, not subject to production testing.

ELECTRICAL CHARACTERISTICS CURVES

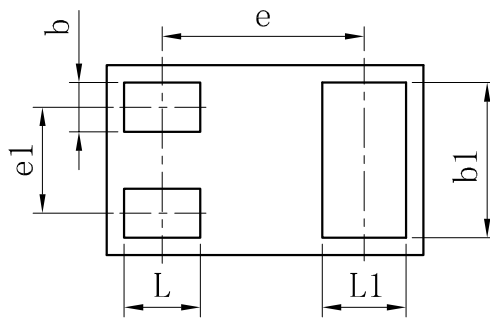




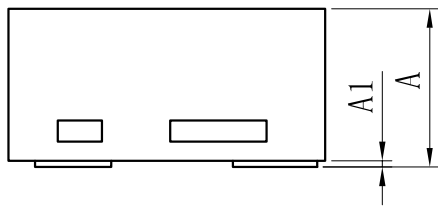
OUTLINE AND DIMENSIONS



TOP VIEW



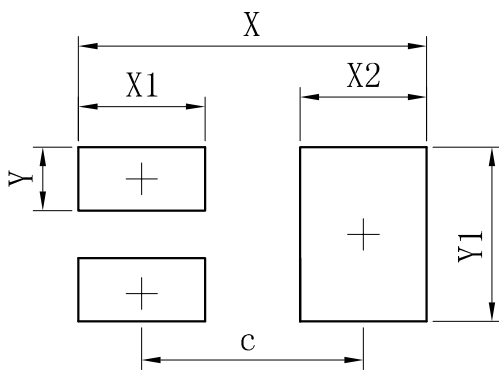
BOTTOM VIEW



SIDE VIEW

SOT883			
DIM	MIN	TYP	MAX
D	0.95	1.00	1.05
E	0.55	0.60	0.65
e	-	0.64	-
e1	-	0.34	-
L	0.19	0.24	0.29
L1	0.22	0.27	0.32
b	0.10	0.15	0.20
b1	0.44	0.49	0.54
A	0.43	0.48	0.53
A1	0	-	0.05
All Dimensions in mm			

SOLDERING FOOTPRINT



Dimensions	(mm)
c	0.70
X	1.10
X1	0.40
X2	0.40
Y	0.20
Y1	0.55